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8. Nature of Conveyance:	Address: 2-2-7, Yacsu, Chuo-ku Tokyo 104-0028 JAPAN
X AssignmentMerger	
_ Sc curity Agreement Change of Name	Name: Osaka Municipal Government
_ Other: Execution Date: October 23, 2002	Address: 1-3-20, Nakanoshima, Kita-ku Osaka-shi, Osaka JAPAN
	Additional name(s) & address(es) attached? Yes X No
Application number(s) or patent number(s):	
A. Patent Application No.(s) 09/656657 Filed: 9/7/2000	B. Patent No.(s)
Additional numbers attached	9 Ves X No
Name and address of party to whom correspondence concerning document	- 13 <u>A</u> 10
should be mailed: Perry J. Hoffman Michael Best & Friedrich LLC 401 North Michigan Avenue Suite 1900 Chicago, Illinois 60611 Phone. (312) 222-0800	6. Total number of applications and patents involved: 1
	7. Total fee (37 CFR 3.41):\$46.00
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Thomas A. Miller (Reg. No. 36,871) Name of Person Signing Signature	May 14,2003 Date
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Docketing	

PATENT REEL: 014079 FRAME: 0551

	11-21-2000			
FORM PTO-1595 (Rev. 6-93)	II HURH DELDI WARD TODA SAKO HURU BRIN BUWA WE WAR	HEET U.S. DEPARTMENT OF COM		
OMB No. 0651-0011 (exp. 4/94)	II HAN BERA KALI ENIDAKTIK KETA EKIDE EKIDE DIKA	NOV 7 2000		
Tab settings □ □ □ ▼	1015/2/2553	▼		
To the Honorable Commissioner of Patents and 11	rademarks: ribase record the att	ached original documents or copy thereof.		
1. Name of conveying party(les): //-//O Hisaya TAKAHASHI, Hirofumi NAKAMURA Masanobu IZAKI and Junichi KATAYAMA	Name:	2. Name and address of receiving party(les) Name: (1) NEC Corporation and Internal Address: (2) Osaka Municipal Gover (1) 7-1, Shiba 5-chome, Minato-ku, Tokyo, JAPAN (2) 1-3-20, Nakanoshima, Kita-ku Osaka-shi, Osaka, JAPAN		
Additional name(s) of conveying party(les) attached? Yes	§ No (1) 7-1			
3. Nature of conveyance:	(2) 1-			
XX Assignment	Street Addre	Street Address: (1) 7-1, Shiba 5-chome, Minato-ku		
☐ Security Agreement ☐ Change	(2) 1	Tokyo, JAPAN (2) 1-3-20, Nakanoshima, Kita-ku		
•	١	Saka-shi, Osaka, JAPAN		
Execution Date: June 10, 2000	Additional nam	Additional name(s) & address(es) attached? ☐ YesXX No		
4. Application number(s) or patent number(s):	9/656,657 AT	TORNEY DOCKET NO.: 1558-13		
If this document is being filed together with a ne	w application, the execution da	ate of the application is:		
A. Patent Application No.(s)	B. Patent I	No.(s)		
09/656,657				
Addition	nal numbers attached? 🔾 Yes 💆 N	do		
Name and address of party to whom correspond concerning document should be mailed:	lence 6. Total numb	6. Total number of applications and patents involved:		
LAFF, WHITESEL, XXXIXE & SARET, LTD ATTORNEYS AT LAW	7. Total fee (3	7. Total fee (37 CFR 3.41)\$40.00		
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REEL: 014079 FRAME: 0552

Date

ASSIGNMENT AND ADEQUACY

FOR VALUE RECEIVED, the receipt of which is hereby acknowledged,

NEC Corporation 7-1, Shiba 5-chome, Minato-ku, Tokyo, Japan

(hereinafter called "ASSIGNOR") hereby assigns, transfers and sets over to:

NEC Toppan Circuit Solutions, Inc. 2-2-7, Yaesu, Chuo-Ku, Tokyo, 104-0028 Japan

(hereinafter called "ASSIGNEE"), the entire worldwide right, title and interest in and to the inventions known as:

(1) Method for Forming a Cu Interconnect Pattern

Serial No. 09/656,657 Filed: September 7, 2000

Inventors: Hisa

Hisaya TAKAHASHI; Hirofumi NAKAMURA, Masanobu IZAKI; and

Junichi KATAYAMA

(2) <u>Sn-Ag-Cu Solder and Surface Treatment and Parts Mounting Methods Using the Same</u>

Serial No. 09/671,084

Filed: September 27, 2000

and

Serial No. 10/127,927

Filed: April 23, 2002 (a division of S.N. 09/671,084)

Inventors: Toshihick ITO and Shiro HARA

and all rights and privileges under any Letters Patent which may be granted thereon, including all rights, if any, throughout the entire world to sue for all past infringements which may have occurred before the execution of this assignment.

(1) The ASSIGNOR agrees to give aid and assistance, without charge, to said ASSIGNEE but at its expense (a) to execute (i) all necessary papers to be used in connection with these applications and any additional, continuing, or divisional applications, as the ASSIGNEE may deem necessary or expedient, (ii) all papers in connection with any interference or other legal or quasi-legal proceedings relating to

these applications or any additional, continuing, or divisional application thereof, (iii) all papers and documents which may be necessary in connection with making claims to priority rights granted under the provisions of the International Convention for Protection of Industrial Property or similar agreements; (b) to cooperate with ASSIGNEE in every way possible in obtaining evidence and going forward in any such proceedings; and (c) to perform all other affirmative acts which may be necessary or desirable to obtain a grant of a valid patent for said invention in any country throughout the world.

- (2) The ASSIGNOR has agreements with the inventors which commit them to give ASSIGNEE the aid and assistance listed in paragraph (1) above.
- (3) ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks of the United States to issue any and all Letters Patent, included within this assignment, that may be granted upon any patent application or any additional, continuing or divisional applications thereof to the ASSIGNEE, its successors and assigns.
- (4) ASSIGNOR hereby covenants and warrants that it has full right to convey the entire right, title and interest by this instrument, free of any encumbrances and that no other agreement has been or will be executed in conflict herewith.
- (5) ASSIGNOR hereby grants to the law firm of MICHAEL BEST & FRIEDRICH, LLC of Chicago, Illinois, authority and power to insert on this instrument any further identification which may be necessary or desirable for purposes of recordation in the United States Patent and Trademark Office.

REEL: 014079 FRAME: 0554

NEC CORPORATION

October	23,	2002

(Date)

ATTEST:

By: (Title)

Akira Muto

October 23, 2002

(Date)

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Masao Maruyama Chief Manager

Planning Division

Intellectual Asset Operations Unit